

Soldering is defined as "the joining of metals by a fusion of alloys which have relatively low melting points". In other words, you use a metal that has a low melting point to adhere the surfaces to be soldered together. Consider that soldering is more like gluing with molten metal, unlike welding where the base metals are actually melted and combined. Soldering is also a must have skill for all sorts of electrical and electronics work. It is also a skill that must be taught correctly and developed with practice. This tutorial will cover the most common types of soldering required for electronics work. This includes soldering components to printed circuit boards and soldering a spliced wire joint. This presentation came from <http://www.aaroncake.net/electronics/solder.htm>

Soldering Equipment

The Soldering Iron/Gun

The first thing you will need is a soldering iron, which is the heat source used to melt solder. Irons of the 15W to 30W range are good for most electronics/printed circuit board work. Anything higher in wattage and you risk damaging either the component or the board. If you intend to solder heavy components and thick wire, then you will want to invest in an iron of higher wattage (40W and above) or one of the large soldering guns. The main difference between an iron and a gun is that an iron is pencil shaped and designed with a pinpoint heat source for precise work, while a gun is in a familiar gun shape with a large high wattage tip heated by flowing electrical current directly through it.



A 30W Watt Soldering Iron



A 300W Soldering Gun

For **hobbyist electronics** use, a soldering iron is generally the tool of choice as its small tip and low heat capacity is suited for printed circuit board work (such as assembling kits). A soldering gun is generally used in heavy duty soldering such as joining heavy gauge wires, soldering brackets to a chassis or stained glass work.

You should choose a soldering iron with a 3-pronged grounding plug. The ground will help prevent stray voltage from collecting at the soldering tip and potentially damaging sensitive (such as CMOS) components. By their nature, soldering guns are quite "dirty" in this respect as the heat is generated by shorting a current (often AC) through the tip made of formed wire. Guns will have much less use in hobbyist electronics so if you have only one tool choice, an iron is what you want. For a beginner, a 15W to 30W range is the best but be aware that at the 15W end of that range, you may not have enough power to join wires or larger components. As your skill increases, a 40W iron is an excellent choice as it has the capacity for slightly larger jobs and makes joints very quickly. Be aware that it is often best

to use a more powerful iron so that you don't need to spend a lot of time heating the joint, which can damage components.



A variation of the basic gun or iron is the soldering station, where the soldering instrument is attached to a variable power supply. A soldering station can precisely control the temperature of the soldering tip unlike a standard gun or iron where the tip temperature will increase when idle and decrease when applying heat to a joint. However, the price of a soldering station is often ten to one hundred times the cost of a basic iron and thus really isn't an option for the hobby market. But if you plan to do very precise work, such as

surface mount, or spend 8 hours a day behind a soldering iron, then you should consider a soldering station.

The rest of this document will assume that you are using a soldering iron as that is what the majority of electronics work requires. The techniques for using a soldering gun are basically the same with the only difference being that heat is only generated when the trigger is pressed.

Solder

The choice of solder is also important. There several kinds of solder available but only a few are suitable for electronics work. Most importantly, you will only use *rosin core solder*. *Acid core solder* is common in hardware stores and home improvement stores, but meant for soldering copper plumbing pipes and not **electronic circuits**. If acid core solder is used on electronics, the acid will destroy the traces on the printed circuit board and erode the component leads. It can also form a conductive layer leading to shorts.



For most printed circuit board work, a solder with a diameter of 0.75MM to 1.0MM is desirable. Thicker solder may be used and will allow you to solder larger joints more quickly, but will make soldering small joints difficult and increase the likelihood of creating solder bridges between closely spaced PCB pads. An alloy of 60/40 (60% tin, 40% lead) is used for most electronics work. These days, several lead-free solders are available as well. **Kester "44" Rosin Core** solder has been a staple of electronics for many years and continues to be available. It is available in several diameters and has a non-

corrosive flux.

Large joints, such as soldering a bracket to a chassis using a high wattage soldering gun, will require a separate application of brush on flux and a thick diameter solder of several millimeters. Remember that when soldering, the flux in the solder will release fumes as it is heated. These fumes are harmful to your eyes and lungs. Therefore, always work in a well-ventilated area and avoid breathing the smoke created. Hot solder is also dangerous. It is surprisingly easy to splash hot solder onto yourself, which is a thoroughly unpleasant experience. Eye protection is also advised.

Preparing To Solder

Tinning the Soldering Tip

Before use, a new soldering tip, or one that is very dirty, must be tinned. "Tinning" is the process of coating a soldering tip with a thin coat of solder. This aids in heat transfer between the tip and the component you are soldering, and also gives the solder a base from which to flow from.

Step 1: Warm Up the Iron

Warm up the soldering iron or gun thoroughly. Make sure that it has fully come to temperature because you are about to melt a lot of solder on it. This is especially important if the iron is new because it may have been packed with some kind of coating to prevent corrosion.

Step 2: Prepare A Little Space

While the soldering iron is warming up, prepare a little space to work. Moisten a little sponge and place it in the base of your soldering iron stand or in a dish close by. Lay down a piece of cardboard in case you drip solder (you probably will) and make sure you have room to work comfortably.

Step 3: Thoroughly Coat the Tip in Solder

Thoroughly coat the soldering tip in solder. It is very important to cover the entire tip. You will use a considerable amount of solder during this process and it will drip, so be ready. If you leave any part of the tip uncovered it will tend to collect flux residue and will not conduct heat very well, so run the solder up and down the tip and completely around it to totally cover it in molten solder.



Step 4: Clean the Soldering Tip

After you are certain that the tip is totally coated in solder, wipe the tip off on the wet sponge to remove all the flux residue. Do this immediately so there is no time for the flux to dry out and solidify.



Step 5: You're Done!

You have just tinned your soldering tip. This must be done anytime you replace the tip or clean it so that the iron maintains good heat transfer.

Soldering a Printed Circuit Board (PCB)

Soldering a PCB is probably the most common soldering task an electronics hobbyist will perform. The basic techniques are fairly easy to grasp but it is a skill that will take a little practice to master. The best way to practice is to buy a simple electronics kit or assemble a simple circuit (such as an **LED chaser**) on a perf-board. Don't buy that expensive kit or dive into a huge project after only soldering a few joints.

Soldering components onto a PCB involves preparing the surface, placing the components, and then soldering the joint.

Step 1: Surface Preparation:

A clean surface is very important if you want a strong, low resistance solder joint. All surfaces to be soldered should be cleaned well. **3M Scotch Brite pads** purchased from the home improvement, industrial supply store or automotive body shop are a good choice as they will quickly remove surface tarnish but will not abrade the PCB material. Note that you will want *industrial* pads and not the kitchen cleaning pads impregnated with cleaner/soap. If you have particularly tough deposits on your board, then a fine grade of steel wool is acceptable but be very cautious on boards with tight tolerances as the fine steel shavings can lodge between pads and in holes.

Once you have cleaned the board down to shiny copper you can use a solvent such as acetone to clean any bits of the cleaning pad that may remain and to remove chemical contamination from the surface of the board. Methyl hydrate is another good solvent and a bit less stinky than acetone. Be aware that both these solvents can remove ink, so if your board is silk screened, test the chemicals first before hosing down the entire board.

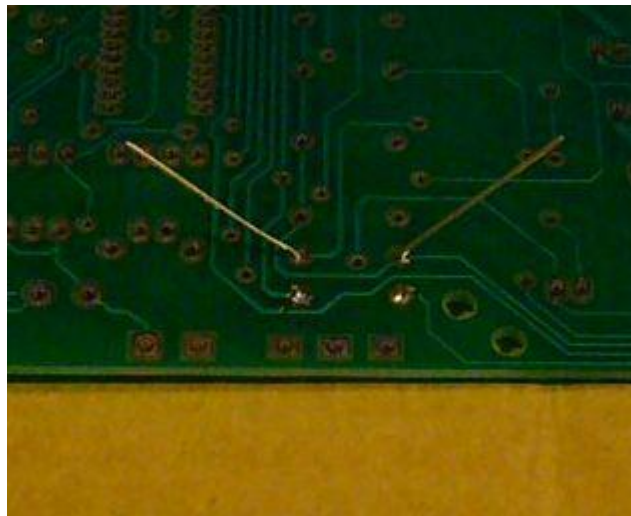
A few blasts with compressed air will dry out the board and remove any junk that may have built up in the holes.

Step 2: Component Placement

After the component and board have been cleaned, you are ready to place the components onto the board. Unless your circuit is simple and only contains a few components, you will probably not be placing all the components onto the board and soldering them at once. Most likely you will be soldering a few components at a time before turning the board over and placing more. In general it is best to start with the smallest and flattest components (resistors, ICs, signal diodes, etc.) and then work up to the larger components (capacitors, power transistors, transformers) after the small parts are done. This keeps the board relatively flat, making it more stable during soldering. It is also best to save sensitive components (MOSFETs, non-socketed ICs) until the end to lessen the chance of damaging them during assembly of the rest of the circuit.

Bend the leads as necessary and insert the component through the proper holes on the board. To hold the part in place while you are soldering, you may want to bend the leads on the bottom of the board at a 45 degree angle. This works well for parts with long leads such as resistors. Components with short leads such as IC sockets can be held in place with a little masking tape or you can bend the leads down to clamp onto the PC board pads.

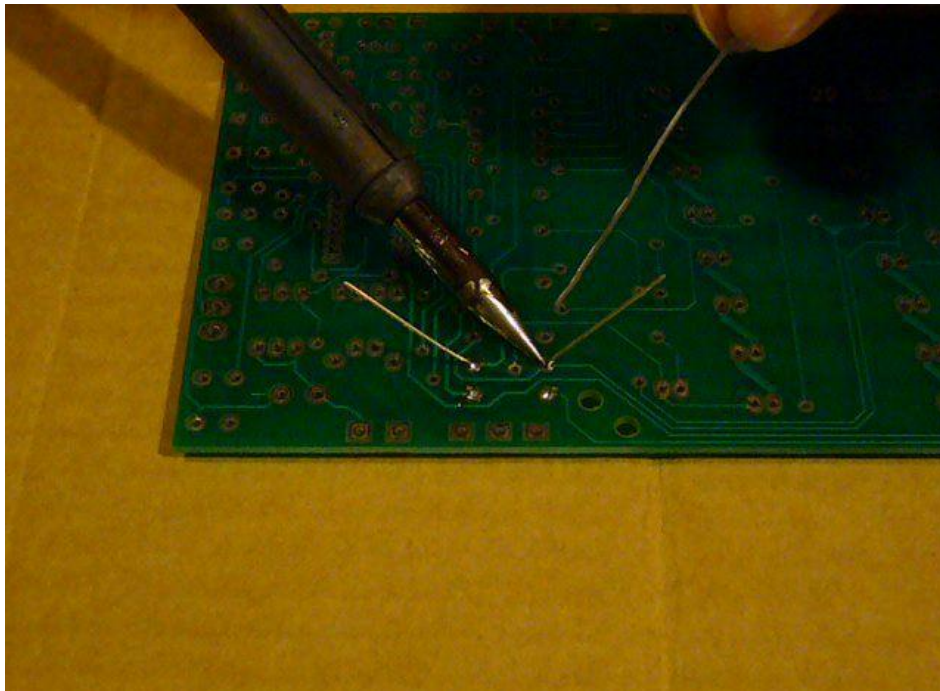
In the image below, a resistor is ready to solder and is held in place by slightly bent leads.



Step 3: Apply Heat

Apply a very small amount of solder to the tip of the iron. This helps conduct the heat to the component and board, but it is **not** the solder that will make up the joint. To heat the joint you will lay the tip of the iron so that it rests against both the *component lead* and the *board*. It is critical that you heat the lead and the board, otherwise the solder will simply pool and refuse to stick to the unheated item. The small amount of solder you applied to the tip before heating the joint will help make contact between the board and the lead. It normally takes a second or two to get the joint hot enough to solder, but larger components and thicker pads/traces will absorb more heat and can increase this time.

If you see the area under the pad starting to bubble, **stop** heating and remove the soldering iron because you are overheating the pad and it is in danger of lifting. Let it cool, then carefully heat it again for much less time.



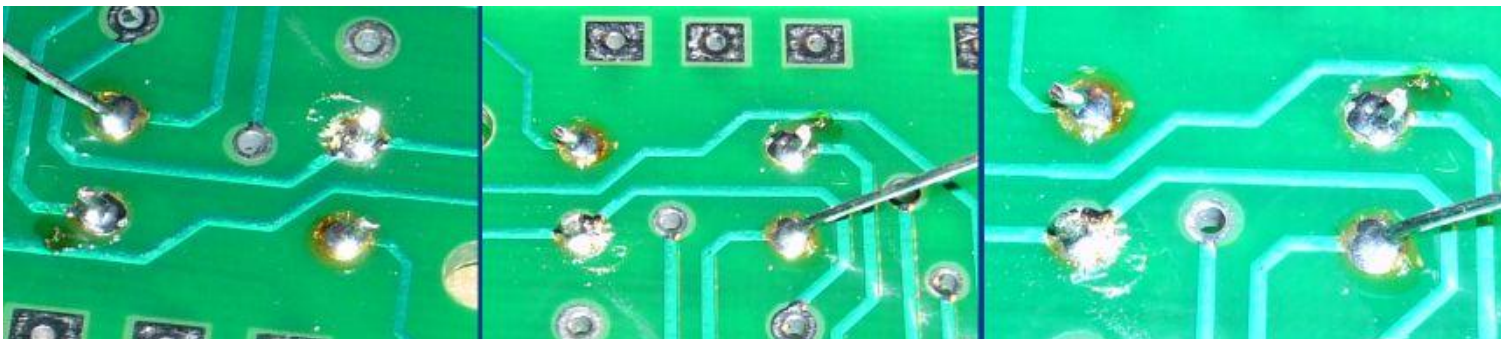
Step 4: Apply Solder to the Joint

Once the component lead and solder pad has heated up, you are ready to apply solder. Touch the tip of the strand of solder to the component lead and solder pad, but **not** the tip of the iron. If everything is hot enough, the solder should flow freely around the lead and pad. You will see the flux melt liquefy as well, bubble around the joint (this is part of its cleaning action), flow out and release smoke. Continue to add solder to the joint until the pad is completely coated and the solder forms a small mound with slightly concave sides. If it starts to ball up, you have used too much solder or the pad on the board is not hot enough.

Once the surface of the pad is completely coated, you can stop adding solder and remove the soldering iron (in that order). Don't move the joint for a few seconds as the solder needs time to cool and solidify. If you do move the joint, you will get what's called a "cold joint". This is recognized by its characteristic dull and grainy appearance. Many cold joints can be fixed by reheating and applying a small amount of solder, then being allowed to cool without being disturbed.

Step 5: Inspect the Joint and Cleanup

Once the joint is made you should inspect it. Check for cold joints (described a little above and at length below), shorts with adjacent pads or poor flow. If the joint checks out, move on to the next. To trim the lead, use a small set of side cutters and cut at the top of the solder joint.



After you have made all the solder joints, it is good practice to clean all the excess flux residue from the board. Some fluxes are hygroscopic (they absorb water) and can slowly absorb enough water to become slightly conductive. This can be a significant issue in a hostile environment such as an automotive application. Most fluxes will clean up easily using methyl hydrate and a rag but some will require a stronger solvent. Use the appropriate solvent to remove the flux, then blow the board dry with compressed air.

Cold Solder Joints

A "cold solder joint" can occur when not enough heat is applied to the component, board, or both. Another common cause is a component moving before the solder has completely cooled and solidified. A cold joint is brittle and prone to physical failure. It is also generally a very high resistance connection which can affect the operation of the circuit or cause it to fail completely.

Cold joints can often be recognized by a characteristic grainy, dull gray color, but this is not always the case. A cold joint can often appear as a ball of solder sitting on the pad and surrounding the component lead. Additionally you may notice cracks in the solder and the joint may even move. Below is the shocking image of every example of a bad solder joint you will ever see. It appears that this **FM transmitter kit** was assembled using the technique of "apply solder to iron then drip onto joint". If your joints are looking like this, then **stop** and practice after rereading this page. Note that not a single of of these joints is acceptable, but amazingly, the circuit worked.



Most cold solder joints can be easily fixed. Generally all that is required is to reheat the joint and apply a little more solder. If there is already too much solder on the joint, then the joint will have to be **desoldered** and then soldered again. This is done by first removing the old solder with a desoldering tool or simply by heating it up and flicking it off with the iron. Once the old solder is off, you can resolder the joint, making sure to heat it thoroughly and keep it still as it cools.